SBC-477-TCA7

Rugged Compact Carrier with Intel Atom[®] x6425RE COM Express Type 6 Module, Mini PCle expansion and USB 3.0

Product Manual



Revision History

Document Version	Last Updated Date	Brief Description of Change
v1.0	11/26/2024	Initial release
v1.1	07/02/2025	Updated warranty page and product images Updated product number, mechanical drawings and ordering information Updated USB 2.0 and USB 3.0 information Removed VGA and mSATA options

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1. Before You Begin

Review the warnings in this section and the best practice recommendations (See "Best Practices" on page 37.) when using and handling the WINSYSTEMS SBC-477-TCA7 module. Following these recommendations provides an optimal user experience and prevents damage. Read through this document and become familiar with the SBC-477-TCA7 before proceeding.



APPLYING CONFORMAL COATING AFTER PURCHASE WILL VOID YOUR WARRANTY. FAILING TO COMPLY WITH THESE BEST PRACTICES MAY DAMAGE THE PRODUCT AND VOID YOUR WARRANTY.

1.1 Warnings

Only qualified personnel should configure and install the SBC-477-TCA7. While observing best practices, pay particular attention to the following:



Avoid Electrostatic Discharge (ESD)

Only handle the circuit board and other bare electronics when electrostatic discharge (ESD) protection is in place. Having a wrist strap and a fully grounded workstation is the minimum ESD protection required before the ESD seal on the product bag is broken.

2. Introduction

This manual provides configuration and usage information for the SBC-477-TCA7. If you still have questions, contact Technical Support at +1-817-274-7553, Monday through Friday, between 8 AM and 5 PM Central Standard Time (CST).

Refer to the WINSYSTEMS website at https://www.winsystems.com/ for other accessories (including cable drawings and pinouts) that can be used with your SBC-477-TCA7.

3. Functionality

This SBC-477-TCA7 COM and Carrier combination is a compact SBC board which matches the dimensions of a COM Express[®] Type 6 Basic module and offers the ultimate durability with locking, rugged pin headers.

The SBC-477-TCA7 is ideal for space constrained applications, harsh environments, demanding conditions and supports extended temperature ranges of -40°C to +85°C.

The COM module is an industrial COM Express Type 6 Compact module with an Atom[®] x6425RE processor. The small form factor module is designed as a processor mezzanine that can be plugged onto a carrier board that contains user-specific I/O requirements.

COM Express modules allow users to retain the same carrier board design across scalable CPU series and over multiple generations of COM Express modules providing a long project lifetime. Updating a COM Express module to improve performance or replace an end of life processor drastically improves time to market when revising existing projects. Users have the option to choose the default BIOS settings and layout, or request a custom branded configurable BIOS to support specific project requirements.

The SBC-477-TCA7 supports Microsoft[®] Windows 10 IoT Enterprise Microsoft[®] Windows 11 IoT Enterprise and Linux (Ubuntu) operating systems. Drivers are available from the WINSYSTEMS website at https://www.winsystems.com/.

4. Product Features and Specifications

Carrie	er Board Features and Specifications
Compatibility	COM Express Type 6 Modules
	PICMG COM Express [®] COM.0 R2.0
Processor	Intel [®] Atom [®] Elkhart Lake x6425RE
	Core Speed: 1.9 GHz
	Cache: 1.5 MB L2
	Power: 12W typical
Memory	16GB or 32GB DDR4 SODIMM
Expansion	Mini PCle Expansion: Both sockets support PCle and USB 2.0. One socket support SIM Card expansion.
	2x Full length cards
	1x SIM Card option
Storage	2x SATA Ports (With External Locking Connectors)
Network	2x Ethernet Ports
	1x Port 0, Intel I226IT, 2.5Gb from COM Express
	1x Port 1, 1Intel 82574I, 1Gb from Carrier
Security	On-board discrete TPM 2.0 hardware security
	vPro [®] Security Platform
GPIO	8-bit GPIO
USB 2.0	6x USB 2.0 Ports (2 used for miniPCle)
USB 3.0	2x USB 3.0 Ports
Display	2x DisplayPort++ (DDI) interface
	Which can be used for DisplayPort, HDMI, DVI or VGA
	1 x LVDS interface (single ch 24-bit, dual ch 48-bit)
Audio	HD Audio (Cirrus Logic CS4207 codec)
	1x stereo input
	1x stereo output
Serial	1x Console RS-232 port (TX/RX)
	2x RS-232 (w/ full modem signals)
	2x RS-422/485
Operating System	Microsoft [®] Windows 11 IoT Enterprise
	Microsoft® Windows 10 IoT Enterprise
	Linux (Ubuntu)
	Other x86 real-time OS
Software	Custom configurable UEFI based AMI BIOS
	System Management Libraries and Tools
External Interfaces	SMBus
	• 12C
	Battery Low Indication
	PC speaker Interface
	System Status (S3 and Reset Outputs)

Carrie	er Board Features and Specifications			
V _{CC}	Input: +12V DC input +/- 5% (5mm pitch terminal connector)			
	(Recommend power supplies with > 60W power budget)			
Battery	On-board RTC Battery 3V 48mAh (BR1125A)			
	With option to select from RTC external battery)			
I/0 Connectors	All low-profile shrouded locking ruggedized 2mm pitch headers.			
	Can be mated to panel mountable cable set or MIL type connectors.			
1/0	8-bit GPIO			
	• 2x USB 3.0			
	6x USB 2.0 (2 used for Mini PCIe)			
	2x miniPCle			
	1x Console RS-232 (TX/RX)			
	2x RS-232 (w/ full modem signals)			
	• 2x RS-422/485			
	SMBus			
	• I2C			
Mechanical	SBC-477-TCA7-1 is 125mm x 95mm x 35mm			
Information	SBC-477-TCA7-2 is 125mm x 95mm x 52mm			
Weight	SBC-477-TCA7-1 is 355g / 12.5oz			
	SBC-477-TCA7-2 is 425g / 15.0oz			
Thermal Solution	SBC-477-TCA7-1 with Heat Spreader			
	SBC-477-TCA7-2 with Heatsink			
MTBF	717,128 hrs			
Operating	-40°C to +85°C (-40°F to +185°F)			
Temperature	(See NOTE below table)			
Humidity (RH)	5% to 95% non-condensing			
RoHS compliant	Yes			
CE Compliant	Yes			
Warranty and Support	Limited two-year Warranty and Free Technical Support			

NOTE Requires appropriate thermal solution to achieve maximum 85°C such as our SBC-477-TCA7-2. The maximum measurable temperature on any spot of the heat spreader or heat sink, and module surfaces must not exceed the operating temperature specified in the table above.

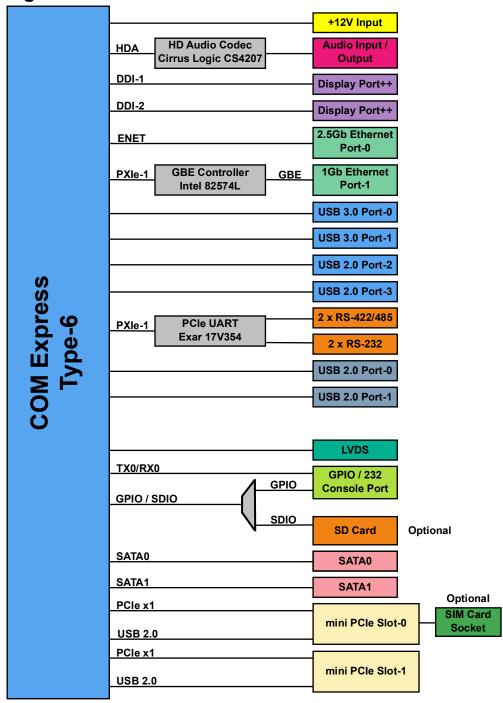
Contact Winsystems at https://winsystems.com/contact/ for more information.

5. Part Numbers / Ordering Information

Part Number	Descr	ription	
SBC-477-TCA7-1	With Heatspreader		
SBC-477-TCA7-2	With Heatsink		
Part Number	Top View	Bottom View	
SBC-477-TCA7-1		C C C C C C C C C C C C C C C C C C C	
SBC-477-TCA7-2		Constitution and the second se	

6. Product Overview

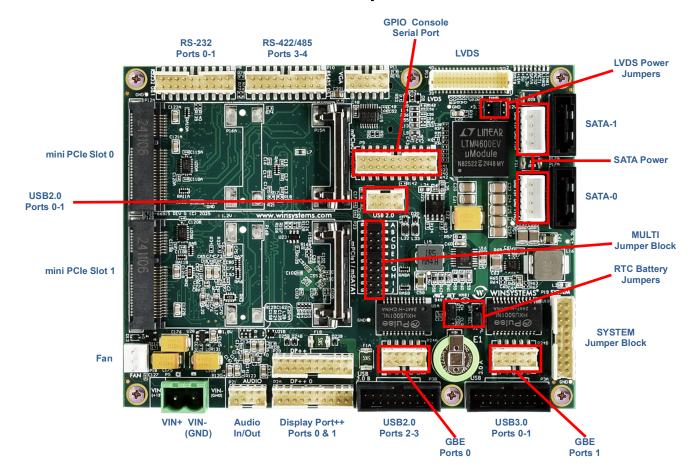
6.1 Block Diagram



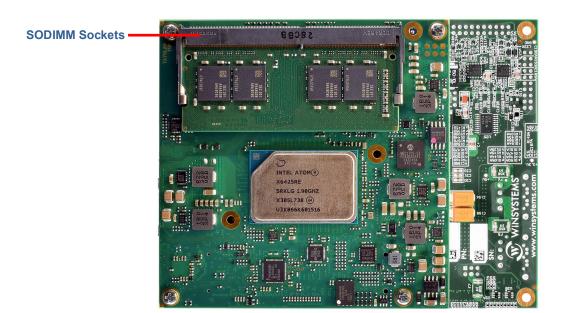
7. Connector Locations

This section describes the SBC-477-TCA7 components and configuration.

Carrier Top View



COM and Carrier Bottom View



Carrier Bottom View

(Showing Options Below)



micro SD Card Slot P4

SIM Card Slot for mini PCle P20

(See NOTE Below)

NOTE SIM's Card option requires a WAN interface controller card that allows the device to connect to a wide area network.

8. Carrier Jumper and Connector Summary

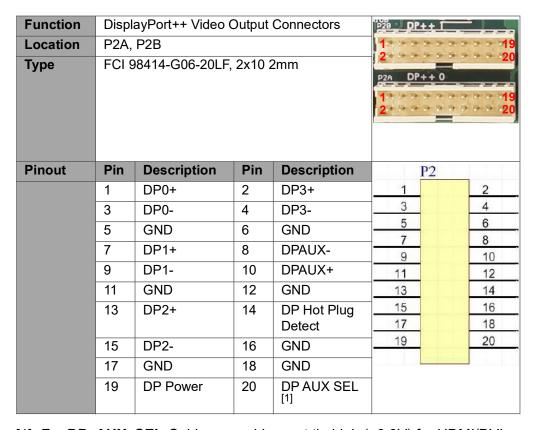
ltem	Description	Reference
P2A	DisplayPort ++ Video	page 15
P2B		
РЗА	USB 3.0 Ports 0, 1	page 16
Р3В	USB 2.0 Ports 2,3	page 17
P4	Micro SD card (Optional)	page 18
P5	+12VDC Power In	page 19
P6, P7	External SATA HDD Power	page 29
P8, P10	Asynchronous Serial Ports	page 20
P8	RS232 Ports 1 & 2	page 21
P9	GPIO and COM Express Type 6 simple serial	page 23
P10	Serial Connector RS-422/485 Ports 3 & 4	page 21
P12A, P12B	miniPCle Slots	page 24
P12A, P12B	Full Length mini PCle Installation	page 25
P13	LVDS Video	page 27
P17A, P17B	External SATA	page 29
P18	CPU FAN Power	page 30
P19	Miscellaneous Control Header	page 30
P20	SIM card slot (Optional)	page 31
P21	Stereo Audio In and Out	page 31
P22	USB2.0 Connector	page 32
P23	Multifunction Jumper Block	page 33
P24A	10/100/1000 Ethernet	page 32
P24B		
J1	RTC Clear	page 20
J2	RTC Selection	page 20
J3	LVDS power selection	page 28

9. Detailed Feature Pinouts and Descriptions

9.1 DisplayPort ++ Video [P2A,P2B]

The SBC-477-TCA7 Carrier features two DisplayPort++ connectors. This can be configured to output Display Port and HDMI/DVI.

The configuration of each interface is setup via the COM Express module's BIOS settings. Refer to the COM Express module's documentation for more details.



[1]- For **DP_AUX_SEL**-Cable assembly must tie high (+3.3V) for HDMI/DVI output and low (GND) for DisplayPort output.

9.2 HDMI / DVI / VGA from DisplayPort++

The SBC-477-TCA7 DisplayPort++ connector can be used for display outputs other than DisplayPort. The use of HDMI, DVI or VGA can be done through a simple dongle or cable assembly like the ones shown below. These can be purchased from any OEM vendor (such as www.startech.com) or contact Winsystems.







9.3 USB 3.0 Ports [P3A]

The SBC-477-TCA7 implements 2x USB 3.0 ports on one 19-pin header, 2x USB 2.0 ports on a second19-pin header, 2x USB 2.0 ports on 8-pin headers and 2x through the miniPCle slots. Below is a description of the 19-pin USB 3.0 header on the SBC-477-TCA7 carrier.

Each USB 3.0 port is capable of bitrates of up to 5Gbps, as well as accepting USB 2.0 connections.

Function	Dual	, USB 3.0		USB P3A	
Location	P3A				1 200 2 100 200 10
Туре		Locking Motherboonnector	oard S	tyle 19-pin USB	49-111
Pinout	Pin	Description	Pin	Description	
	-	-	1	P1-VBUS	
	19	P2-VBUS	2	P1-SSRX	
	18	P2-SSRX-	3	P1-SSRX+	
	17	P2-SSRX+	4	GND	
	16	GND	5	P1-SSTX-	
	15	P2-SSTX-	6	P1-SSTX+	
	14	P2-SSTX+	7	GND	
	13	GND	8	P1-D-	
	12	P2-D-	9	P1-D+	
	11	P2-D+	10	-	

9.4 USB 2.0 Ports [P3B]

Below is a description of the 19-pin USB 2.0 header on the SBC-477-TCA7 carrier.

Function	Dual,	USB 2.0		USB TO THE	
Location	РЗВ				10
Туре		Locking Motherbo	oard S	tyle 19-pin USB	1 1
Pinout	Pin	Description	Pin	Description	
	-	-	1	P1-VBUS	
	19	P2-VBUS	2	-	
	18	-	3	-	
	17	-	4	GND	
	16	GND	5	-	
	15	-	6	-	
	14	-	7	GND	
	13	GND	8	P1-D-	
	12	P2-D-	9	P1-D+	
	11	P2-D+	10	-	

9.5 MicroSD Card [P4] (Optional)

The SBC-477-TCA7 provides a Micro SD Card Slot at P4. This Micro SD Card slot sources the SDIO interface from the COM Express modules GPIO pins.

NOTE This SD card slot will ONLY operate if the COM Express module provides the SDIO interface over the GPIO pins. See below for the SDIO / GPIO mapping.

Also ensure **MULTI-JUMPER position "B"** is installed to select the SDIO interface.

Function	micro SD Card Slot				
Locations	P4				
Туре	Micro	SD Card Socket	Molex 502570-089	3	
Pinout	Pin	SDIO Signal	COM Express GPIO Mapping	PAGE US	
	1	SD D2	GPI2	17V354 18176 18176	
	2	SD D3	GPI3	CTF 2313 GG6U04.09	
	3	SD CMD	GP01		
	4	SD_VCC	-	micro SD Card Slot	
		(+3.3V)			
	5	SD CLK	GPO0		
	6	GND	-		
	7	SD D0	GPIO		
	8	SD D1	GPI1		
	9	GND	-		
	10	SD CD#	GP03		

9.6 Input Power [P5]

The SBC-477-TCA7 is designed to be powered from a regulated single +12VDC power supply. The carrier board features a 5mm screw terminal style connector. The COM Express carrier generates all of the necessary voltages on board from this single input.

Function	Main	Input Power			
Locations	P5				
Range	+12V	/ DC (+/-5%)			
Туре	2 Po	sition 5mm pitch	terminal connector		
	Matir	ng Connector:			
	PN: 7	796634-2			
	MFG	: TE Connectivit	у		
Power	Reco	mmend power s	upplies with > 60W	power budget.	
Supply					
Fuse	+12V	is protected wit	h a one-time 10A fu	se, at F4.	
Pinout	Pin	Signal	Description	C127 P5 C	R130+
	1	+12V	Power In		
	2	GND	Power Return	(+1 60	VIN-
	*DO NOT REVERSE POLARITY!				
				VIN+	VIN-
				+12V	GND

9.7 RTC Battery [J1, J2]

The Panasonic Lithium battery (BR1225A/FA) provides 3V@48mAh to VBAT. VBAT is the supply for the RTC Clock of the COM Express module.

If the BR1225A is not sufficient for the application, an external battery can be connected to P19 with J2 selection jumper set appropriately.

NOTE The battery ships with a non-conductive label to prevent accidental discharge. It can be removed before installation.

Function	RTC Clear		Dm
Locations	J1		100
Туре	1x3		
Pinout	Location	Description	* Co
	1-2	Enable RTC	PC
	2-3	Clear CMOS	المركزيل
Function	RTC Battery Selection		
Locations	J2		9
Type	1x3		→ [1250]

Description

External battery

Local On-board Battery

9.8 Asynchronous Serial Ports [P8, P10]

Location

1-2

2-3

Pinout

The SBC-477-TCA7 features four "external" serials ports. PortI and Port2 are standard RS-232 and Port3 and Port4 can be configured as RS-422/485. These serial ports are generated from on-board PCie 4-port UART the Exar 17V358

9.9 Software Support for the Exar 17V358

Additional drivers will be needed to properly operate the 4 additional serial ports on the COM Express carrier. Drivers for this functionality can be found on Winsystems website: https://www.winsystems.com/.

9.10 Serial Connector RS-232 [P8]

Function	RS232 Serial					
Location	P8			19		
Туре	FCI 98424-G52-20LF, 2x10 2mm			20 20		
Pinout	Pin	Description	Pin	Description		
	1	Port A, DCD	2	Port A, DSR	P8	
	3	Port A, RXD	4	Port A, RTS	3 4	
	5	Port A, TXD	6	Port A, CTS	5 6	
	7	Port A, DTR	8	Port A, RI	7 8	
	9	GND	10	-	9 10 12	
	11	Port B, DCD	12	Port B,DSR	13 14	
	13	Port B,RXD	14	Port B,RTS	15 16	
	15	Port B,TXD	16	Port B,CTS	17 18 20	
	17	Port B,DTR	18	Port B,RI	10 20	
	19	GND	20	-		

9.11 Serial Connector RS-422/485 Ports 3 & 4 [P10]

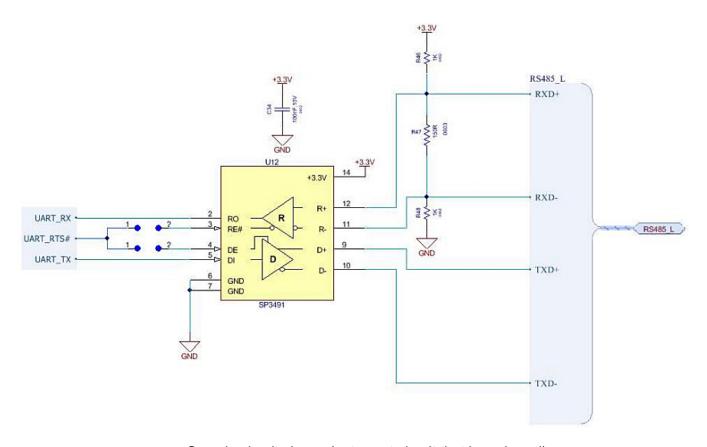
Function	RS-4	22/485 Serial		a a a al Pio	
Location	P10		19: 2 2 2 2 2	1 K	
Туре	FCI 98424-G52-20LF, 2x10 2mm		20 2 LUUUUUUUUUU		
Pinout	Pin	Description			
	1	Port A, RXD+	P10		
	3	Port A, TXD+	1	2	
	5	Port A, TXD-	3	4	
	7	Port A, RXD-	57	6 8	
	9	GND	9	10	
	11	Port B,RXD+	11	12	
	13	Port B,TXD+	13	14	
		·	15	16	
	15	Port B,TXD-	17	18	
	17	Port B,RXD-	19	20	
	19	GND			

9.12 RS485 Control Jumpers

The RS485 Control Jumpers are used for implementing the following RS485 modes of operations:

- 1/2 Duplex Multidrop
- Full Duplex Multidrop

The UART RTS signals can used for TX/RX control and can be enable via the MULTI jumper block. See below for the RS-422/485 circuit diagram.



Sample circuit shown (not exact circuit that is on-board)

9.13 GPIO and Console Serial Port [P9]

The SBC-477-TCA7 provides additional functionality of COM Express Type-6 specification.

Function	Cons	ole RS-232 / GP	IO	- pg	'	1	± C1	2/ HJC 17
Location	P9							
Туре	FCI 98424-G52-20LF			19 19 19 19 19 19 19 19	10	4 5		1.2
Pinout	Pin	Description	Pin	Description		1 8 1	P9	4 1 1
	1	GPIO Input 0	2	GPIO Output 3	_	1		2
	3	GPIO Input 1	4	GPIO Output 2	-	5		6
	5	GPIO Input 2	6	GPIO Output 1		7	2-1-1	8
	7	GPIO Input 3	8	GPIO Output 0		9		10
	9	GND	10	-	(11		12
	11	-	12	-	0.0	13 15	S	14
	13	RS-232 RX	14	-	/	17		18
	15	RS-232 TX	16	-	-	19		20
	17	-	18	-	1			
	19	GND	20	-				

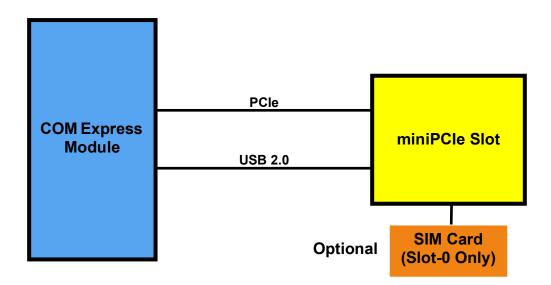
9.14 miniPCle Slots [P12A, P12B]

Dual Function miniPCle Slots

The SBC-477-TCA7 has two special dual purpose functionality mini PCIe slots. Each of these slots can accept a mini PCIe module. These slots have special circuitry that allows for connecting PCIe lanes.

Each of these slots are also provided with a USB 2.0 in addition to the PCIe as per the mini PCIe specification, see below for a block diagram of the slots functionality.

A SIM Card can be used in Slot-0 only.



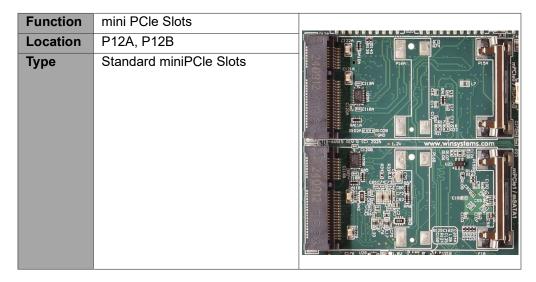
PCIe / USB 2.0 Dual Functionality Diagram

Selection for the miniPCle on and off is done on the MULTI-JUMPER block (P23)

Position	Jumper ON
С	Slot-0 miniPCle selected
D	Slot-1 miniPCle selected

9.15 Full Length mini PCle Installation [P12A, P12B]

The SBC-477-TCA7 comes with its latches in the full length position.



Position

mSATA Pinout

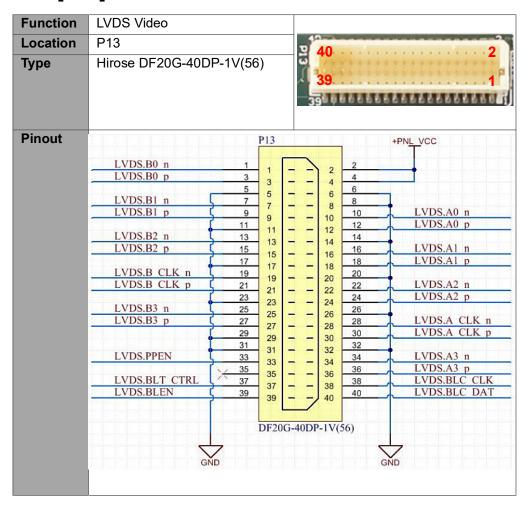
Pin Number	Description
1	NC
2	+3.3V
3	NC
4	GND
5	NC
6	+1.5V
7	NC
8	NC
9	GND
10	NC NC
11	NC NC
12	NC NC
13	NC NC
14	NC CND
15	GND
16	NC NC
17	NC
18	GND
19	NC
20	NC
21	RESV
22	NC
23	SATA TX+ To Host System
24	+3.3V
25	SATA TX- To Host System
26	GND
27	GND
28	+1.5V
29	GND
30	NC
31	SATA RX- From Host System
32	NC
33	SATA RX+ From Host System
34	GND
35	GND
36	NC
37	GND
38	NC NC
39	+3.3V
40	GND
40	+3.3V
42	NC PECA
43	RESV
44	NC NC
45	NC
46	NC
47	NC
48	+1.5V
49	NC
50	GND
51	NC
52	+3.3V

miniPCle Pinout

Pin Number	Description	
1	NC	
2	+3.3V	
3	NC	
4	GND	
5	NC	
6	+1.5V	
7	CLKREQ#	
8	UIM_PWR	
9	GND	
10	UIM_DATA	
11	PCIe CLK+	
12	UIM_CLK	
13	PCIe CLK-	
14	UIM_RESET	
15	GND	
16	UIM_VPP	
17	NC	
18	GND	
19	NC	
20	W_DISABLE#	
21	RESV	
22	NC	
23	PCIe RX+ To Host System	
24	+3.3V	
25	PCIe RX- To Host System	
26	GND	
27	GND	
28	+1.5V	
29	GND	
30	SMB_CLK	
31	PCIe TX- From Host System	
32	SMB_DATA	
33	PCIe TX+ From Host System	
34	GND	
35	GND	
36	USB D-	
37	GND	
38	USB D+	
39	+3.3V	
40	GND	
41	+3.3V	
42	NC NC	
43	RESV	
44	NC NC	
45	NC NC	
46	NC NC	
47	NC .1 EV	
48	+1.5V	
49	NC CND	
50	GND	
51	NC	
52	+3.3V	

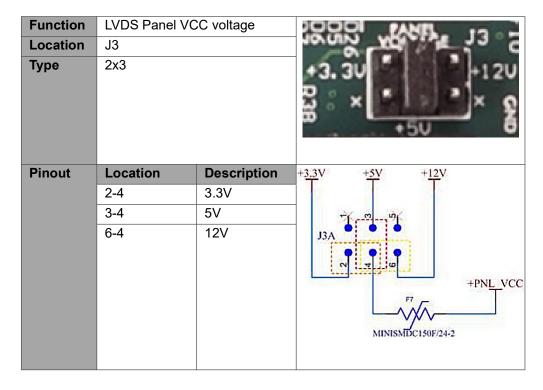
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9.16 LVDS Video [P13]



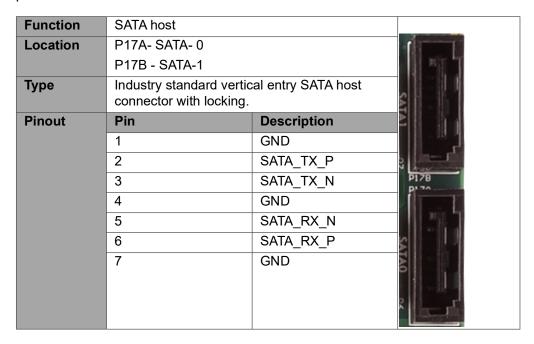
9.17 LVDS power selection [J3]

The LVDS Panel VCC voltage is selected via the J3 jumper block. The current is limited to 1.5A

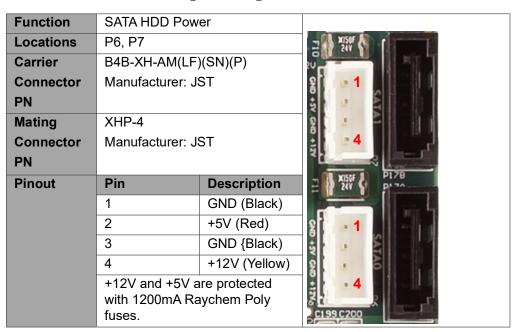


9.18 External SATA Ports [P17A, P17B]

The SBC-477-TCA7 provides two SAT A HDD connections as well as external power connectors for each drive.



9.19 External SATA HDD Power [P6, P7]



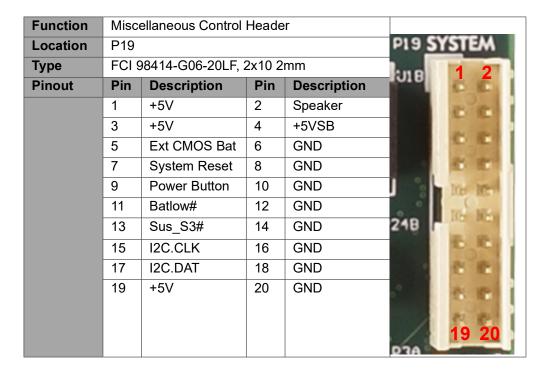
NOTE The SATA power connectors are fused independently from the main +12V fuse that provides + 2V power to the board, i.e. the SATA power connectors are not double fused.

9.20 CPU Fan [P18]

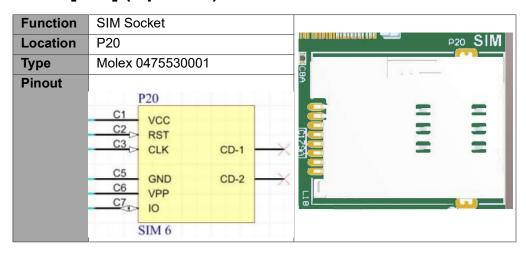
Function	Fan Power		
Locations	P18	P18	
Туре	Molex 22-2	Molex 22-23-2031	
Pinout	Pin	Signal	
	1	Fan Tach	
	2	+V	
	3	GND	

9.21 Miscellaneous Control Header [P19]

This misc header can be used to connect power button, reset button, PC speaker, I2C device and monitor other power rails. As well it provides the option of jumping the +5V rail to the +5VSB rail which may be needed by some modules.

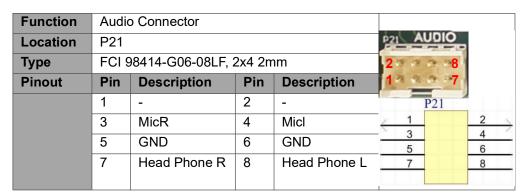


9.22 SIM card slot [P20] (Optional)



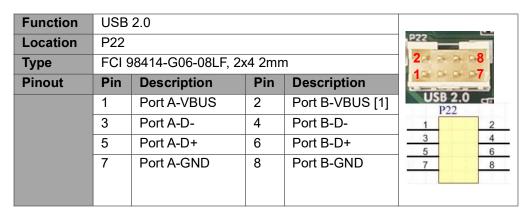
9.23 Audio Interface [P21]

The SBC-477-TCA7 features HD Audio capabilities. 1 input (microphone) and 1 output (headphone) are available.



9.24 USB2.0 Connector [P22]

The SBC-477-TCA7 external USB 2.0 ports. Each of these are directly sourced from the COM Express Type 6 module and do not go through any external hubs or bridges.



[1] - **B-VBUS**- This voltage can be disable for USB Client mode on USB port 6, by un-installing jumper P23 position A.

9.25 10/100/1000 Ethernet [P24A, P24B]

The SBC-477-TCA7 features dual 10/100/1000 Ethernet Ports Ethernet Port 0 is coming directly from the COM Express module. Ethernet Port 1 is coming from an Intel 82574 PCIe PHY Controller located on the carrier.

Function	LAN	Connector			
Location	P24A, P24B				P210
Туре	FCI 9	98424-G52-10LF			M to the the the
Pinout	Pin Description Pin Description				
	1	MX1-	2	MX1+	
	3	MX2-	4	MX2+	
	5	SHELL	6	SHELL	P24B
	7	MX3-	8	MX3+	PPPPP
	9	MX4-	10	MX4+	0

9.26 Software Support for the Intel 82574

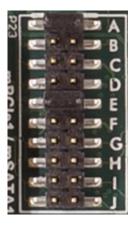
Additional drivers will be needed to properly operate the GBE Port 0 on the COM Express carrier.

These drivers can be downloaded directly from link below.

https://www.intel.com/content/www/us/en/download-center/home.html?lang=eng&ProductFamily=Ethemet+Components&ProductLine=Ethemet+Controllers&ProductProduct=Intel%C2%AE+82574+Gigabit+Ethemet+Controller

9.27 Multifunction Jumper Block [P23]

The SBC-477-TCA7 has a multi-function jumper that provides control for various interfaces and features. The "MULTI" jumper is located at P23.



Below are the full details of the MULTI jumper block functionality.

Position	Description	JUMPER IN	JUMPER OFF
Α	USB Port-6 Client/Host	Port-6 USB Host enabled. Power connected	Port-6 USB Client enabled. Power Disconnected
В	SD Card/ GPIO Mux	SD Card Functionality is enabled	GPIO Functionality is enabled
С	miniPCle Slot-0 Selection	miniPCle enabled	-
D	miniPCle Slot-1 Selection	miniPCle enabled	-
E	PCIe UART EEPROM	Enable PCIe UART EEPROM	Disable PCle UART EEPROM
F	PCIe UART - TRI State Enable	Enable TRI-State control for PCle UART	Disable TRI-State control for PCIe UART
G	PCIe UART - 485 Port 0- RTS-TX Control	Enable RS-485 Port-0 RTS-TX Control	Disable RS-485 Port-0 RTS· TX Control
Н	PCIe UART - 485 Port 0- RTS-RX Control	Enable RS-485 Port-0 RTS-RX Control	Disable RS-485 Port-0 RTS-RX Control
I	PCIe UART - 485 Port 1- RTS-TX Control	Enable RS-485 Port-1 RTS-TX Control	Disable RS-485 Port·1 RTS· TX Control
J	PCIe UART - 485 Port 1- RTS-RX Control	Enable RS-485 Port-1 RTS-RX Control	Disable RS-485 Port-1 RTS-RX Control

10. Typical Hardware Installation for +12V power input

- 1. Ensure all external system power supplies are off.
- 2. Install the necessary cables for the application. At a minimum, this would include:
 - a) + 12V Power cable to the input power connector.
 - b) Connect a video display cable HDMI, Display Port or LVDS.
 - c) Keyboard and mouse via USB
 - d) SATA Power and Signal to SATA HDD

For the relevant cables, see the Cables and Cable Kit Information section of this manual

- 3. Connect the power cable to power supply
- 4. Switch on the power supply. DO NOT power up your COM Express system by plugging in live power.

11. Power Consumption Details

Below are the maximum ratings of the carrier.

Maximums	Amps	Watts
The absolute maximum total draw of all functionality on the carrier board (this value excludes current draw from the module).	4.00A	48W
Safety Protected Maximum Current Draw Rating for Module and Carrier (from in-line fuse).	10.00A	120W

NOTE COM Express Type-6 Module used for measurements - Intel Core i5 Ivy Bridge 2700MHz Quad-Core Processor with QM77 chipset.

12. PCI Express Allocation Details

Below is a listing of how the PCI Express Links are allocated on the carrier board.

COM Express PCI Express Link	Peripheral Connection
PCle x1 -0	PCle UART (Exar 17V354)
PCle x1 -1	miniPCle Slot 0
PCle x1 -2	miniPCle Slot 1
PCle x1 -3	PCIe GBE PHY (Intel 82574)
PCle x1 -4	No Connect
PCle x1 -5	No Connect
PCle x1 -6	No Connect
PCle x1 -7	No Connect
PEG /PCle x16	No Connect

13. USB Allocation Details

Below is a listing of how the USB Ports are allocated on the carrier board.

COM Express USB Port	Peripheral Connection
USB 3.0 Port 0	USB 3.0 A Connector (P3A)
USB 3.0 Port 1	USB 3.0 A Connector (P3A)
USB 2.0 Port 2	USB 3.0 B Connector (P3B)
USB 2.0 Port 3	USB 3.0 B Connector (P3B)
USB 2.0 Port 4	miniPCle Slot 0
USB 2.0 Port 5	miniPCle Slot 1
USB 2.0 Port 6	USB 2.0 Connector (P22)
USB 2.0 Port 7	USB 2.0 Connector (P22)

14. Cables

Cable Set	
Part Number	
CBL-SET-477-CNT-1	SATA HDD Signal and Power Cable
	Dual USB 2.0 to 8-Pin Minitek Cable
	DisplayPort to 20-pin Minitek Cable
	20-Pin Minitek to Flying Leads
	JR-45 to 10-Pin Minitek Cable
	Dual Audio to 8-Pin Minitek Cable
	VGA to 10-Pin Minitek Cable
	Dual DB-9 to 20-Pin Minitek Cable
	Dual USB 3.0 Panel Mount to 20-pin Locking Intl Style: Right Angle Inner Exit
	Dual USB 3.0 Panel Mount to 20-pin Locking Intl Style: Right Angle Outer Exit
	Dual USB 3.0 Panel Mount to 20-pin Locking Intl Style: Right Angle Vertical Exit

Contact Winsystems at https://winsystems.com/contact/ for cables options.

Appendix A. Best Practices

The following paragraphs outline the best practices for operating the SBC-477-TCA7 in a safe, effective manner, that does not damage the board. Read this section carefully.

Power Supply



Avoid Electrostatic Discharge (ESD)

Only handle the circuit board and other bare electronics when electrostatic discharge (ESD) protection is in place. Having a wrist strap and a fully grounded workstation is the minimum ESD protection required before the ESD seal on the product bag is broken.

Power Supply Budget

Evaluate your power supply budget. It is usually good practice to budget twice the typical power requirement for all of your devices.

Zero-load Power Supply

Use a zero-load power supply whenever possible. A zero-load power supply does not require a minimum power load to regulate. If a zero-load power supply is not appropriate for your application, then verify that the SBC-477-TCA7 typical load is not lower than the power supply's minimum load. If the SBC-477-TCA7 board does not draw enough power to meet the power supply's minimum load, then the power supply does not regulate properly and can cause damage to the SBC-477-TCA7.



Use Proper Power Connections (Voltage)

When verifying the voltage, measure it at the power connector on the carrier board. Measuring it at the power supply does not account for voltage drop through the wire and connectors.

The SBC-477-TCA7 requires 12VDC input (+/- 5%) to operate. Verify the power connections. Incorrect voltages can cause catastrophic damage.

Power Harness

Minimize the length of the power harness. This reduces the amount of voltage drop between the power supply and the SBC-477-TCA7.

Gauge Wire

Use the largest gauge wire that the pin and connector manufacture allows. Most pin and connector manufacturers have a maximum gauge wire they recommend for their pins.

Contact Points

WINSYSTEMS boards mostly use connectors with gold finish contacts. Gold finish contacts are used exclusively on high-speed connections. Power and lower speed peripheral connectors may use a tin finish as an alternative contact surface. It is critical that the contact material in the mating connectors is matched properly (gold to gold and tin to tin). Contact areas made with dissimilar metals can cause oxidation/corrosion, resulting in unreliable connections.

Pin Contacts

Often the pin contacts used in cabling are not given enough attention. The ideal choice for a pin contact would include a design similar to Molex or Trifurcon designs, which provide three distinct points to maximize the contact area and improve connection integrity in high shock and vibration applications.

Power Down

Make sure that power has been removed from the system before making or breaking any connections.



Power Supply OFF—Always turn off the power supply before connecting to the embedded system. Do not hot-plug the SBC-477-TCA7 on a host carrier board that is already powered.

I/O Connections OFF—Turn off all I/O connections before connecting them to the embedded computer modules or any I/O cards. Connecting hot signals can cause damage whether the embedded system is powered or not.

Mounting and Protecting the SBC-477-TCA7

To avoid damage, mount the SBC-477-TCA7 properly. Standoff kits are available and recommended for use with the SBC-477-TCA7.

Placing the SBC-477-TCA7 on mounting standoffs—Be careful when placing the SBC-477-TCA7 on the mounting standoffs. Sliding the board around until the standoffs are visible from the top can cause component damage on the bottom of the board.

Do not bend or flex the SBC-477-TCA7—Bending or flexing can cause irreparable damage. Embedded computer modules are especially sensitive to flexing or bending around ball grid array (BGA) devices. BGA devices are extremely rigid by design, and flexing or bending the embedded computer module can cause the BGA to tear away from the printed circuit board.

Mounting holes—The mounting holes are plated on the top, bottom, and through the barrel of the hole. Traces are often routed in the inner layers right below, above, or around the mounting holes.

- Never use a drill or any other tool in an attempt to make the holes larger.
- Never use screws with oversized heads. The head could come in contact with nearby components causing a short or physical damage.
- Never use self-tapping screws; they compromise the walls of the mounting hole.
- Never use oversized screws that cut into the walls of the mounting holes.
- Always use all of the mounting holes. By using all of the mounting holes, you provide the support the embedded computer module needs to prevent bending or flexing.

Avoid cutting the SBC-477-TCA7—Never use star washers or any fastening hardware that cut into the SBC-477-TCA7.

Avoid over-tightening of mounting hardware—Causing the area around the mounting holes to compress could damage interlayer traces around the mounting holes.

Use appropriate tools—Always use tools that are appropriate for working with small hardware. Large tools can damage components around the mounting holes.

Conformal Coating

Conformal coating by any source other than WINSYSTEMS voids the product warranty and will not be accepted for repair by WINSYSTEMS. If such a product is sent to WINSYSTEMS for repair, it will be returned at customer expense and no service will be performed. A WINSYSTEMS product conformally coated by WINSYSTEMS will be subject to regular WINSYSTEMS warranty terms and conditions.

Operations/Product Manuals

Every WINSYSTEMS product has an Operations manual or Product manual.

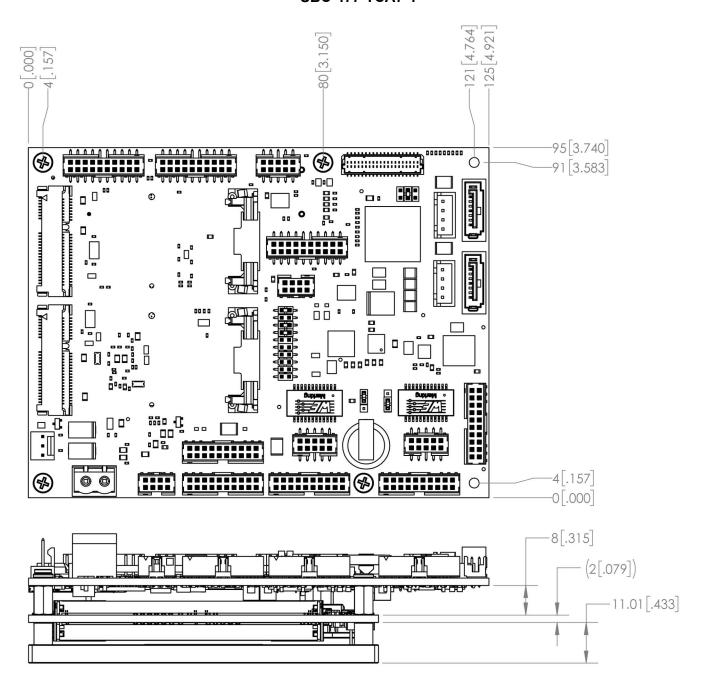
Periodic updates—Operations/product manuals are updated often. Periodically check the WINSYSTEMS website https://www.winsystems.com/for revisions.

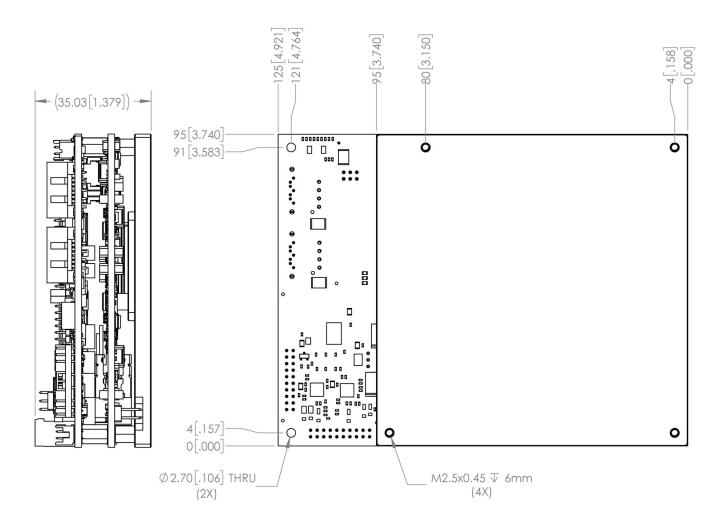
Check pin-outs—Always check the pin-out and connector locations in the manual before plugging in a cable. Many I/O modules have identical headers for different functions and plugging a cable into the wrong header can have disastrous results.

Contact an applications engineer—If a diagram or chart in a manual does not seem to match your board, or if you have additional questions, contact a WINSYSTEMS applications engineer at +1-817-274-7553.

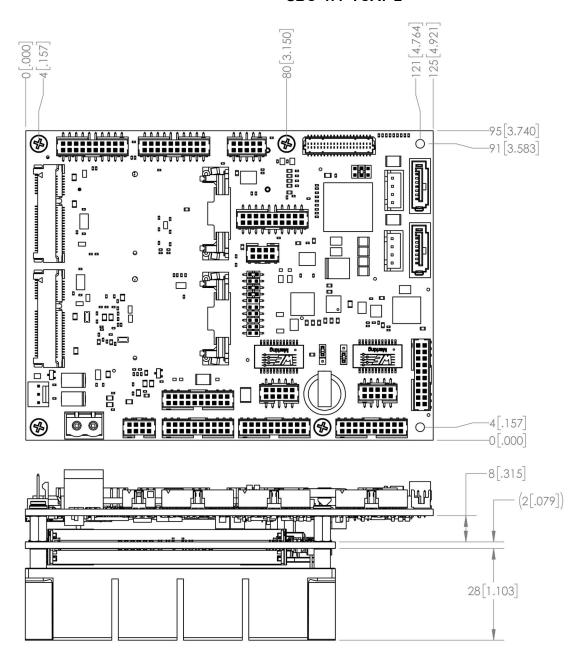
Appendix B. Mechanical Drawings

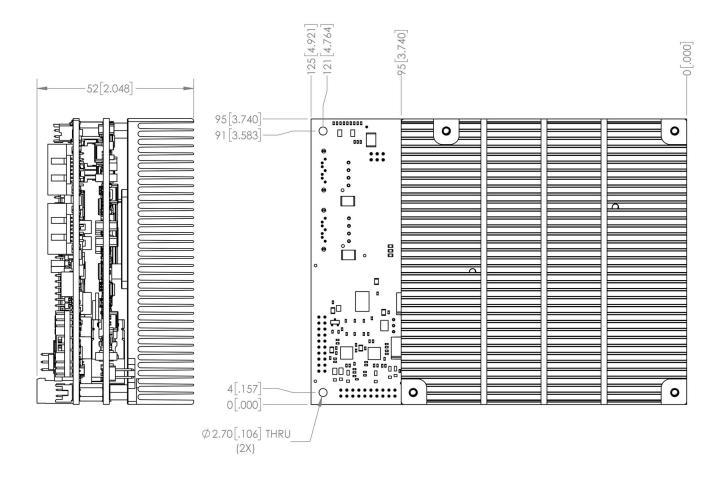
SBC-477-TCA7-1





SBC-477-TCA7-2





Appendix C. Warranty Information

Full warranty information is at https://winsystems.com/company-policies/warranty/